74HC2G02-Q100; 74HCT2G02-Q100

Dual 2-input NOR gate Rev. 2 — 26 July 2018

Product data sheet

1. General description

The 74HC2G02-Q100; 74HCT2G02-Q100 is a dual 2-input NOR gate. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
 - Wide supply voltage range from 2.0 V to 6.0 V
- Input levels:
 - For 74HC2G02-Q100: CMOS level
 - For 74HCT2G02-Q100: TTL level
- Symmetrical output impedance
- High noise immunity
- Complies with JEDEC standard no. 7A (4.5 V to 5.5 V)
- Low power dissipation
- Balanced propagation delays
- Multiple package options
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)

3. Ordering information

| Table 1. Ordering inform | ation | | | | | | |
|--------------------------|-------------------|--------|---|----------|--|--|--|
| Type number | Package | | | | | | |
| | Temperature range | Name | Description | Version | | | |
| 74HC2G02DP-Q100 | -40 °C to +125 °C | TSSOP8 | plastic thin shrink small outline package; | SOT505-2 | | | |
| 74HCT2G02DP-Q100 | | | 8 leads; body width 3 mm; lead length 0.5 mm | | | | |
| 74HC2G02DC-Q100 | -40 °C to +125 °C | VSSOP8 | plastic very thin shrink small outline package; | SOT765-1 | | | |
| 74HCT2G02DC-Q100 | | | 8 leads; body width 2.3 mm | | | | |

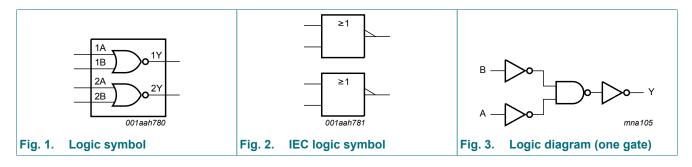
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4. Marking

| Table 2. Marking code Type number | Marking code [1] |
|-----------------------------------|------------------|
| 74HC2G02DP-Q100 | H02 |
| 74HCT2G02DP-Q100 | T02 |
| 74HC2G02DC-Q100 | H02 |
| 74HCT2G02DC-Q100 | T02 |

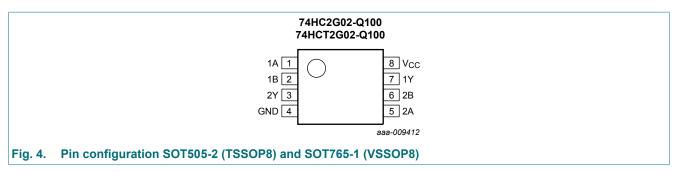
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



6. Pinning information

6.1. Pinning



6.2. Pin description

| Table 3. Pin description | | | | | |
|--------------------------|------|----------------|--|--|--|
| Symbol | Pin | Description | | | |
| 1A, 2A | 1, 5 | data input | | | |
| 1B, 2B | 2, 6 | data input | | | |
| GND | 4 | ground (0 V) | | | |
| 1Y, 2Y | 7, 3 | data output | | | |
| V _{CC} | 8 | supply voltage | | | |

7. Functional description

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level.

| Input | | Output |
|-------|----|--------|
| nA | nB | nY |
| L | L | Н |
| L | Н | L |
| Н | L | L |
| Н | Н | L |

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|---------------------------|--|----|------|------|------|
| V _{CC} | supply voltage | | | -0.5 | +7.0 | V |
| I _{IK} | input clamping current | $V_{\rm I} < -0.5 \ V \ {\rm or} \ V_{\rm I} > V_{\rm CC} + 0.5 \ V$ [| 1] | - | ±20 | mA |
| I _{OK} | output clamping current | $V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V [| 1] | - | ±20 | mA |
| lo | output current | $V_{\rm O}$ = -0.5 V to (V _{CC} + 0.5 V) [| 1] | - | 25 | mA |
| I _{CC} | supply current | [| 1] | - | 50 | mA |
| I _{GND} | ground current | [| 1] | -50 | - | mA |
| T _{stg} | storage temperature | | | -65 | +150 | °C |
| P _D | dynamic power dissipation | T _{amb} = -40 °C to +125 °C | 2] | - | 300 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP8 package: above 55 °C the value of P_{tot} derates linearly with 2.5 mW/K.

For VSSOP8 package: above 110 °C the value of P_{tot} derates linearly with 8 mW/K.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

| Symbol | bol Parameter Conditions | | 74HC2G02-Q100 | | | 74HCT2G02-Q100 | | | Unit |
|------------------|--------------------------|-------------------------|---------------|------|-----------------|----------------|------|-----------------|------|
| | | | Min | Тур | Max | Min | Тур | Max | |
| V _{CC} | supply voltage | | 2.0 | 5.0 | 6.0 | 4.5 | 5.0 | 5.5 | V |
| VI | input voltage | | 0 | - | V _{CC} | 0 | - | V _{CC} | V |
| Vo | output voltage | | 0 | - | V _{CC} | 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | +25 | +125 | -40 | +25 | +125 | °C |
| Δt/ΔV | input transition | V _{CC} = 2.0 V | - | - | 625 | - | - | - | ns/V |
| | rise and fall rate | V _{CC} = 4.5 V | - | 1.67 | 139 | - | 1.67 | 139 | ns/V |
| | | V _{CC} = 6.0 V | - | - | 83 | - | - | - | ns/V |

10. Static characteristics

Table 7. Static characteristics

Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -4 | 0 °C to +85 | -40 °C to +125 °C | | Unit | |
|-----------------|--------------------------|---|------|-------------|-------------------|------|------|----|
| | | | Min | Typ [1] | Max | Min | Max | |
| 74HC2G | 02-Q100 | 1 | | _ | I | | | - |
| VIH | HIGH-level input | V _{CC} = 2.0 V | 1.5 | 1.2 | - | 1.5 | - | V |
| | voltage | V _{CC} = 4.5 V | 3.15 | 2.4 | - | 3.15 | - | V |
| | | V _{CC} = 6.0 V | 4.2 | 3.2 | - | 4.2 | - | V |
| V _{IL} | LOW-level input | V _{CC} = 2.0 V | - | 0.8 | 0.5 | - | 0.5 | V |
| | voltage | V _{CC} = 4.5 V | - | 2.1 | 1.35 | - | 1.35 | V |
| | | V _{CC} = 6.0 V | - | 2.8 | 1.8 | - | 1.8 | V |
| V _{OH} | HIGH-level output | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | | |
| | voltage | I_{O} = -20 µA; V_{CC} = 2.0 V | 1.9 | 2.0 | - | 1.9 | - | V |
| | | I_{O} = -20 µA; V_{CC} = 4.5 V | 4.4 | 4.5 | - | 4.4 | - | V |
| | | I _O = -20 μA; V _{CC} = 6.0 V | 5.9 | 6.0 | - | 5.9 | - | V |
| | | I _O = -4.0 mA; V _{CC} = 4.5 V | 4.13 | 4.32 | - | 3.7 | - | V |
| | | I _O = -5.2 mA; V _{CC} = 6.0 V | 5.63 | 5.81 | - | 5.2 | - | V |
| V _{OL} | LOW-level output | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | | |
| | voltage | I _O = 20 μA; V _{CC} = 2.0 V | - | 0 | 0.1 | - | 0.1 | V |
| | | I _O = 20 μA; V _{CC} = 4.5 V | - | 0 | 0.1 | - | 0.1 | V |
| | | I _O = 20 μA; V _{CC} = 6.0 V | - | 0 | 0.1 | - | 0.1 | V |
| | | I _O = 4.0 mA; V _{CC} = 4.5 V | - | 0.15 | 0.33 | - | 0.4 | V |
| | | I _O = 5.2 mA; V _{CC} = 6.0 V | - | 0.16 | 0.33 | - | 0.4 | V |
| I | input leakage current | $V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0 V$ | - | - | ±1.0 | - | ±1.0 | μA |
| I _{CC} | supply current | per input pin; $V_I = V_{CC}$ or GND; $I_O = 0 A$; $V_{CC} = 6.0 V$ | - | - | 10 | - | 20 | μA |
| CI | input capacitance | | - | 1.5 | - | - | - | pF |
| 74HCT2 | G02-Q100 | | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 4.5 V to 5.5 V | 2.0 | 1.6 | - | 2.0 | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 4.5 V to 5.5 V | - | 1.2 | 0.8 | - | 0.8 | V |
| V _{OH} | HIGH-level output | V _I = V _{IH} or V _{IL} | | | | | | |
| voltage | | I _O = -20 μA; V _{CC} = 4.5 V | 4.4 | 4.5 | - | 4.4 | - | V |
| | | I _O = -4.0 mA; V _{CC} = 4.5 V | 4.13 | 4.32 | - | 3.7 | - | V |
| V _{OL} | LOW-level output | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | | |
| | voltage | I _O = 20 μA; V _{CC} = 4.5 V | - | 0 | 0.1 | - | 0.1 | V |
| | | I _O = 4.0 mA; V _{CC} = 4.5 V | - | 0.15 | 0.33 | - | 0.4 | V |

| Symbol | ymbol Parameter Conditions | | -40 | °C to +85 | °C | -40 °C to | Unit | |
|------------------|----------------------------|---|-----|-----------|------|-----------|------|----|
| | | | Min | Тур [1] | Max | Min | Мах | |
| l _l | input leakage current | $V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5 V$ | - | - | ±1.0 | - | ±1.0 | μA |
| I _{CC} | supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 10 | - | 20 | μA |
| ∆l _{CC} | additional supply current | per input; V_{CC} = 4.5 V to 5.5 V; V _I = V _{CC} - 2.1 V; I _O = 0 A | - | - | 375 | - | 410 | μA |
| CI | input capacitance | | - | 1.5 | - | - | - | pF |

[1] All typical values are measured at T_{amb} = 25 °C.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit, see Fig. 6.

| Symbol | Parameter | Conditions | | -40 °C to +85 °C | | | -40 °C to | Unit | |
|-----------------|-------------------------------|---|-----|------------------|---------|-----|-----------|------|----|
| | | Min | | Min | Typ [1] | Max | Min | Max | |
| 74HC2G | 02-Q100 | 1 | | | | | _ | • | |
| t _{pd} | propagation delay | nA and nB to nY; see Fig. 5 | [2] | | | | | | |
| | | V _{CC} = 2.0 V | | - | 26 | 95 | - | 110 | ns |
| | | V _{CC} = 4.5 V | | - | 9 | 19 | - | 22 | ns |
| | | V _{CC} = 5.0 V; C _L = 15 pF | | - | 9 | - | - | - | ns |
| | | V _{CC} = 6.0 V | | - | 8 | 16 | - | 20 | ns |
| t _t | transition time | see Fig. 5 | [3] | | | | | | |
| | | V _{CC} = 2.0 V | | - | 19 | 95 | - | 125 | ns |
| | | V _{CC} = 4.5 V | | - | 7 | 19 | - | 25 | ns |
| | | V _{CC} = 6.0 V | | - | 5 | 16 | - | 20 | ns |
| C _{PD} | power dissipation capacitance | $V_{I} = GND$ to V_{CC} | [4] | - | 10 | - | - | - | pF |
| 74HCT2 | G02-Q100 | 1 | | | | | | 1 | - |
| t _{pd} | propagation delay | nA and nB to nY; see Fig. 5 | [2] | | | | | | |
| | | V _{CC} = 4.5 V | | - | 12 | 24 | - | 29 | ns |
| | | V _{CC} = 5.0 V; C _L = 15 pF | | - | 12 | - | - | - | ns |
| t _t | transition time | V _{CC} = 4.5 V; see <u>Fig. 5</u> | [3] | - | 6 | 19 | - | 22 | ns |
| C _{PD} | power dissipation capacitance | $V_{\rm I} = {\rm GND} \text{ to } V_{\rm CC} - 1.5 \text{ V}$ [4 | | - | 10 | - | - | - | pF |

[1] All typical values are measured at T_{amb} = 25 °C.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] t_t is the same as t_{TLH} and t_{THL} .

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

f_i = input frequency in MHz;

 f_o = output frequency in MHz;

 C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

11.1. Waveforms and test circuit

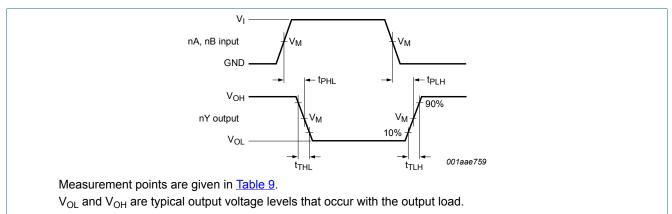


Fig. 5. Propagation delay data input (nA, nB) to data output (nY) and transition time output (nY)

Table 9. Measurement points

| Туре | Input | Output |
|----------------|---------------------|---------------------|
| | V _M | V _M |
| 74HC2G02-Q100 | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |
| 74HCT2G02-Q100 | 1.3 V | 1.3 V |

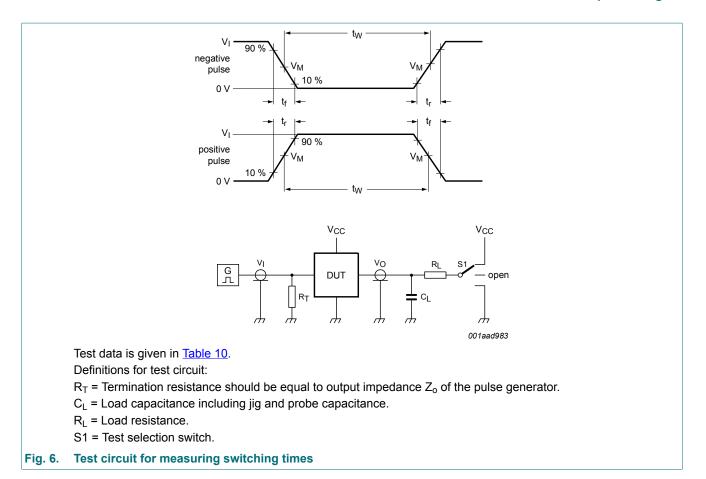


Table 10. Test data

| Туре | Input L | | Load | S1 position | |
|----------------|------------------------|---------------------------------|--------------|-------------|-------------------------------------|
| | VI | t _r , t _f | CL | RL | t _{PHL} , t _{PLH} |
| 74HC2G02-Q100 | GND to V _{CC} | ≤ 6 ns | 15 pF, 50 pF | 1 kΩ | open |
| 74HCT2G02-Q100 | GND to 3 V | ≤ 6 ns | 15 pF, 50 pF | 1 kΩ | open |

12. Package outline

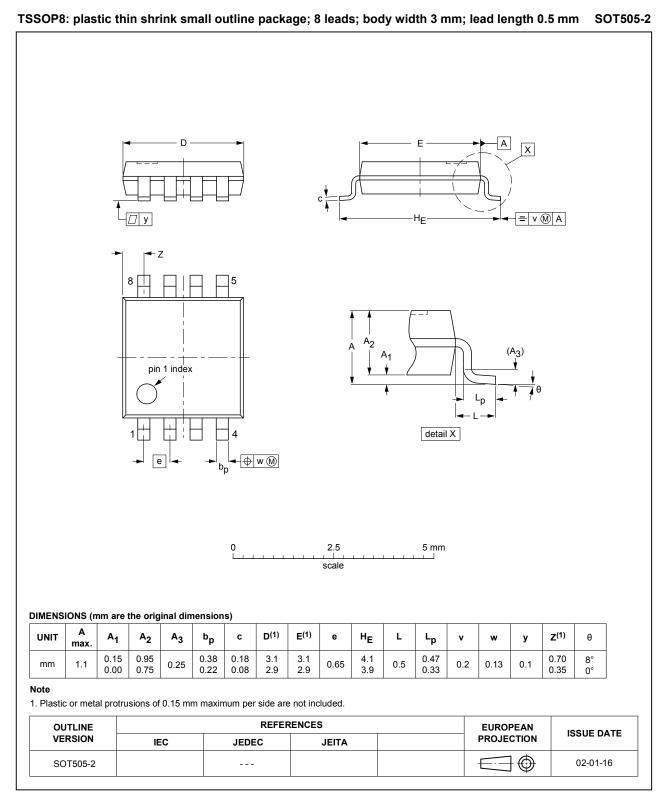


Fig. 7. Package outline SOT505-2 (TSSOP8)

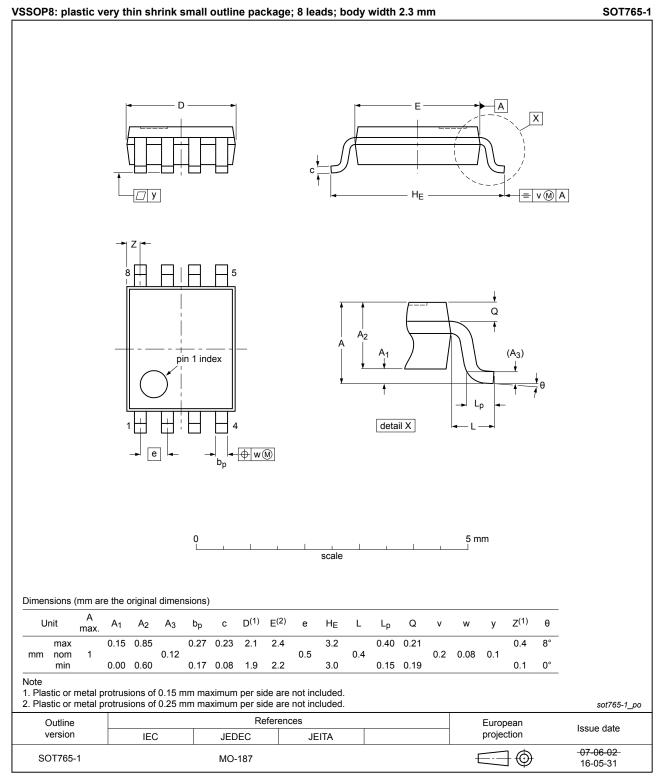


Fig. 8. Package outline SOT765-1 (VSSOP8)

13. Abbreviations

| Table 11. Abbreviat | ions |
|---------------------|---|
| Acronym | Description |
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| НВМ | Human Body Model |
| MIL | Military |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

14. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | |
|-----------------------|---|--------------------|---------------|-----------------------|--|
| 74HC_HCT2G02_Q100 v.2 | 20180726 | Product data sheet | - | 74HC_HCT2G02_Q100 v.1 | |
| Modifications: | The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. | | | | |
| 74HC_HCT2G02_Q100 v.1 | 20131111 | Product data sheet | - | - | |

15. Legal information

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| Document status [1][2] | Product status [3] | Definition |
|-----------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
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